

**N-Ch MOSFET** 

## **General Description**

The WSF22N06 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF22N06 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

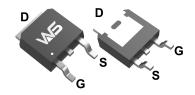
## **Product Summery**

BVDSS	RDSON	ID
60V	65mΩ	18A

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- LCD/LED back light

## **TO-252 Pin Configuration**





## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	60	V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	18	А	
I <sub>D</sub> @T <sub>C</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	12	А	
I <sub>DP</sub>	Pulsed Drain Current <sup>2</sup> 50		А	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	11	mJ	
I <sub>AS</sub>	Avalanche Current	10	Α	
P <b>₀@</b> T <sub>C</sub> =25°C	Total Power Dissipation⁴	42	W	
P <sub>D</sub> @T <sub>c</sub> =100℃	Total Power Dissipation⁴	30	W	
T <sub>STG</sub>	Storage Temperature Range -55 to 150		$^{\circ}$	
$T_J$	Operating Junction Temperature Range -55 to 150		$^{\circ}$	

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>		62.5	°C/W
R <sub>eJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		3.0	°C/W



## Electrical Characteristics (T<sub>J</sub>=25 ℃, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	60			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25℃ , I <sub>D</sub> =1mA		0.057		V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =10A		65	76	mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =5A		75	97	
$V_{GS(th)}$	Gate Threshold Voltage	)/ -\/   -250uA	1.2	1.8	2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-5.68		mV/℃
	Drain-Source Leakage Current	$V_{DS}$ =48V , $V_{GS}$ =0V , $T_J$ =25 $^{\circ}\mathrm{C}$			1	
I <sub>DSS</sub>		V <sub>DS</sub> =48V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	· uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =5A		30		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω
$Q_g$	Total Gate Charge (4.5V)	V <sub>DS</sub> =30V , V <sub>GS</sub> =10V , I <sub>D</sub> =5A		5.5		nC
$Q_gs$	Gate-Source Charge			1.8		
$Q_{gd}$	Gate-Drain Charge			2.1		
$T_{d(on)}$	Turn-On Delay Time			10		
T <sub>r</sub>	Rise Time	VDD=30V, RL=30Ω , IDS=1A,		8		no
T <sub>d(off)</sub>	Turn-Off Delay Time	VGEN=10V, RG=6Ω		25		ns
T <sub>f</sub>	Fall Time			18		
C <sub>iss</sub>	Input Capacitance	VGS=0V, VDS=30V, Frequency=1.0MHz		450		
C <sub>oss</sub>	Output Capacitance			55		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			38		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I <sub>S</sub>	Continuous Source Current <sup>1,6</sup>	$V_G$ = $V_D$ = $0V$ , Force Current			10	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>				35	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	$V_{GS}$ =0V , $I_{S}$ =1A , $T_{J}$ =25 $^{\circ}$ C			1.3	V
t <sub>rr</sub>	Reverse Recovery Time	IF=10A ,dI/dt=100A/µs,TJ=25℃		30		nS
Q <sub>rr</sub>	Reverse Recovery Charge			35		nC

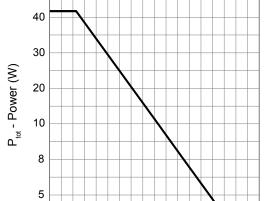
Note a : Pulse test ; pulse width $\leq 300 \, \mu s$ , duty cycle $\leq 2\%$ .

Note b: Guaranteed by design, not subject to production testing.



# **Typical Operating Characteristics**

# Power Dissipation 50

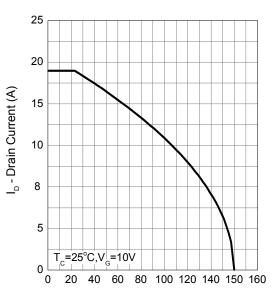


T<sub>i</sub> - Junction Temperature (°C)

80 100 120 140 150 160

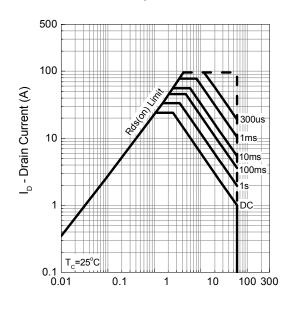
60

## **Drain Current**



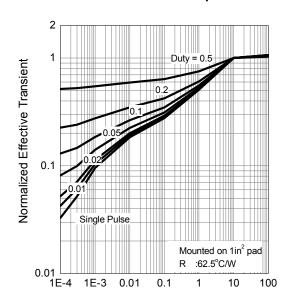
T<sub>i</sub> - Junction Temperature (°C)

## Safe Operation Area



V<sub>DS</sub> - Drain-Source Voltage (V)

## **Thermal Transient Impedance**

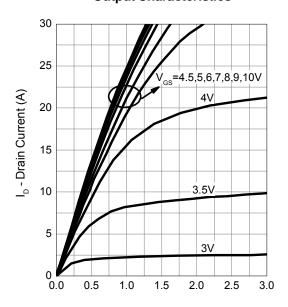


Square Wave Pulse Duration (sec)



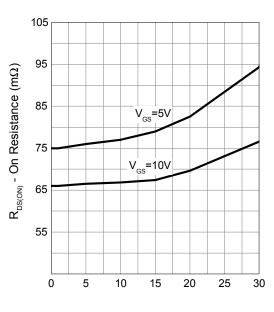
# **Typical Operating Characteristics (Cont.)**

## **Output Characteristics**



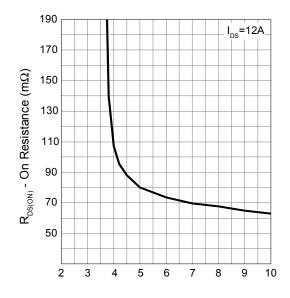
V<sub>DS</sub> - Drain-Source Voltage (V)

#### **Drain-Source On Resistance**



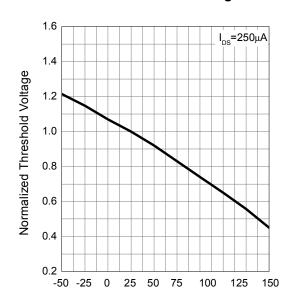
I<sub>D</sub> - Drain Current (A)

## **Gate-Source On Resistance**



V<sub>GS</sub>-Gate-Source Voltage (V)

## **Gate Threshold Voltage**

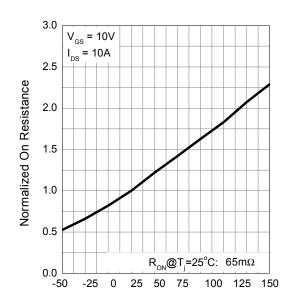


T<sub>i</sub> - Junction Temperature (°C)



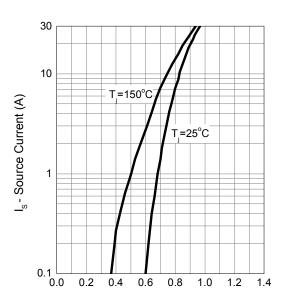
# **Typical Operating Characteristics (Cont.)**

#### **Drain-Source On Resistance**



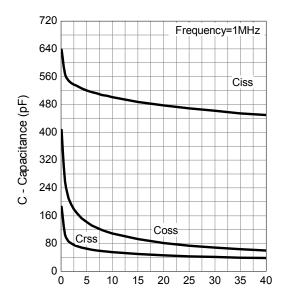
T<sub>i</sub> - Junction Temperature (°C)

#### Source-Drain Diode Forward



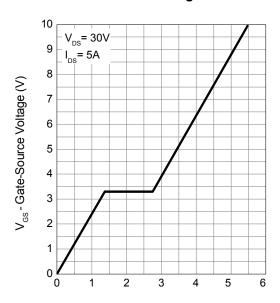
V<sub>SD</sub> - Source-Drain Voltage (V)

## Capacitance



V<sub>DS</sub> - Drain-Source Voltage (V)

## **Gate Charge**



Q<sub>G</sub> - Gate Charge (nC)



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
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